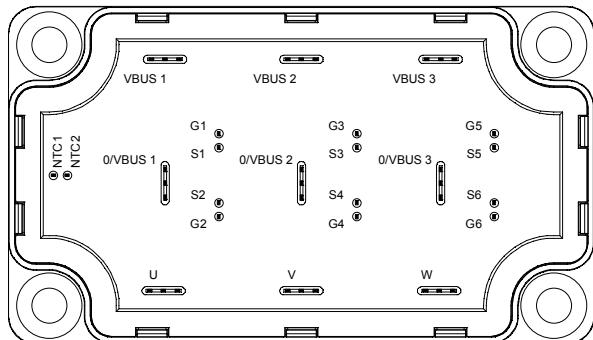
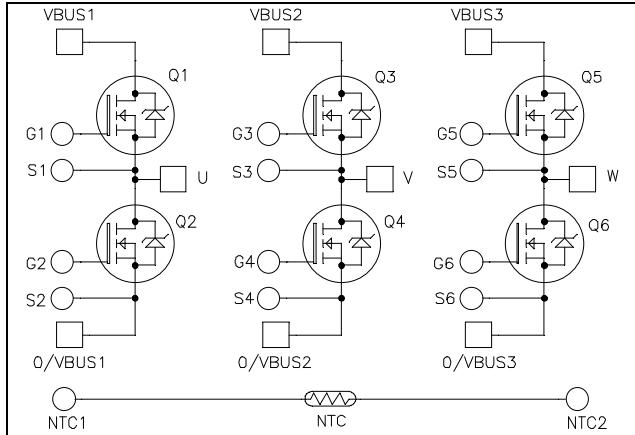


**Triple phase leg
Super Junction MOSFET
Power Module**

V_{DSS} = 600V
R_{DSon} = 24mΩ max @ T_j = 25°C
I_D = 95A @ T_c = 25°C



Absolute maximum ratings

Symbol	Parameter	Max ratings	Unit
V _{DSS}	Drain - Source Breakdown Voltage	600	V
I _D	Continuous Drain Current	T _c = 25°C T _c = 80°C	95 70
I _{DM}	Pulsed Drain current		
V _{GS}	Gate - Source Voltage	±20	V
R _{DSon}	Drain - Source ON Resistance	24	mΩ
P _D	Maximum Power Dissipation	T _c = 25°C 462	W
I _{AR}	Avalanche current (repetitive and non repetitive)	15	A
E _{AR}	Repetitive Avalanche Energy	3	mJ
E _{AS}	Single Pulse Avalanche Energy	1900	

 **CAUTION:** These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed. See application note APT0502 on www.microsemi.com

Application

- Welding converters
- Switched Mode Power Supplies
- Uninterruptible Power Supplies
- Motor control

Features

- **COOLMOS® Power Semiconductors**
 - Ultra low R_{DSon}
 - Low Miller capacitance
 - Ultra low gate charge
 - Avalanche energy rated
 - Very rugged
- Kelvin source for easy drive
- Very low stray inductance
 - Symmetrical design
 - Lead frames for power connections
- High level of integration
- Internal thermistor for temperature monitoring

Benefits

- Outstanding performance at high frequency operation
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Solderable terminals both for power and signal for easy PCB mounting
- Very low (12mm) profile
- Each leg can be easily paralleled to achieve a phase leg of three times the current capability
- Module can be configured as a three phase bridge
- Module can be configured as a boost followed by a full bridge
- RoHS Compliant

All ratings @ $T_j = 25^\circ\text{C}$ unless otherwise specified

Electrical Characteristics

Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit
I_{DSS}	Zero Gate Voltage Drain Current	$V_{GS} = 0\text{V}$, $V_{DS} = 600\text{V}$	$T_j = 25^\circ\text{C}$			350	μA
		$V_{GS} = 0\text{V}$, $V_{DS} = 600\text{V}$	$T_j = 125^\circ\text{C}$			600	
$R_{DS(on)}$	Drain – Source on Resistance	$V_{GS} = 10\text{V}$, $I_D = 47.5\text{A}$				24	$\text{m}\Omega$
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS} = V_{DS}$, $I_D = 5\text{mA}$		2.1	3	3.9	V
I_{GSS}	Gate – Source Leakage Current	$V_{GS} = \pm 20\text{ V}$, $V_{DS} = 0\text{V}$				200	nA

Dynamic Characteristics

Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit
C_{iss}	Input Capacitance	$V_{GS} = 0\text{V}$; $V_{DS} = 25\text{V}$ $f = 1\text{MHz}$			14.4		nF
C_{oss}	Output Capacitance				17		
Q_g	Total gate Charge	$V_{GS} = 10\text{V}$ $V_{Bus} = 300\text{V}$ $I_D = 95\text{A}$			300		nC
Q_{gs}	Gate – Source Charge				68		
Q_{gd}	Gate – Drain Charge				102		
$T_{d(on)}$	Turn-on Delay Time	Inductive Switching (125°C) $V_{GS} = 10\text{V}$ $V_{Bus} = 400\text{V}$ $I_D = 95\text{A}$ $R_G = 2.5\Omega$			21		ns
T_r	Rise Time				30		
$T_{d(off)}$	Turn-off Delay Time				100		
T_f	Fall Time				45		
E_{on}	Turn-on Switching Energy	Inductive switching @ 25°C $V_{GS} = 10\text{V}$; $V_{Bus} = 400\text{V}$ $I_D = 95\text{A}$; $R_G = 2.5\Omega$			1350		μJ
E_{off}	Turn-off Switching Energy				1040		
E_{on}	Turn-on Switching Energy	Inductive switching @ 125°C $V_{GS} = 10\text{V}$; $V_{Bus} = 400\text{V}$ $I_D = 95\text{A}$; $R_G = 2.5\Omega$			2200		μJ
E_{off}	Turn-off Switching Energy				1270		

Source - Drain diode ratings and characteristics

Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit
I_S	Continuous Source current (Body diode)		$T_c = 25^\circ\text{C}$		95		A
			$T_c = 80^\circ\text{C}$		70		
V_{SD}	Diode Forward Voltage	$V_{GS} = 0\text{V}$, $I_S = - 95\text{A}$				1.2	V
dv/dt	Peak Diode Recovery ①					4	V/ns
t_{rr}	Reverse Recovery Time	$I_S = - 95\text{A}$	$T_j = 25^\circ\text{C}$		600		ns
Q_{rr}	Reverse Recovery Charge	$V_R = 350\text{V}$ $dI/dt = 200\text{A}/\mu\text{s}$	$T_j = 25^\circ\text{C}$		34		μC

 ① dv/dt numbers reflect the limitations of the circuit rather than the device itself.

 $I_S \leq - 95\text{A}$ $di/dt \leq 200\text{A}/\mu\text{s}$ $V_R \leq V_{DSS}$ $T_j \leq 150^\circ\text{C}$

Thermal and package characteristics

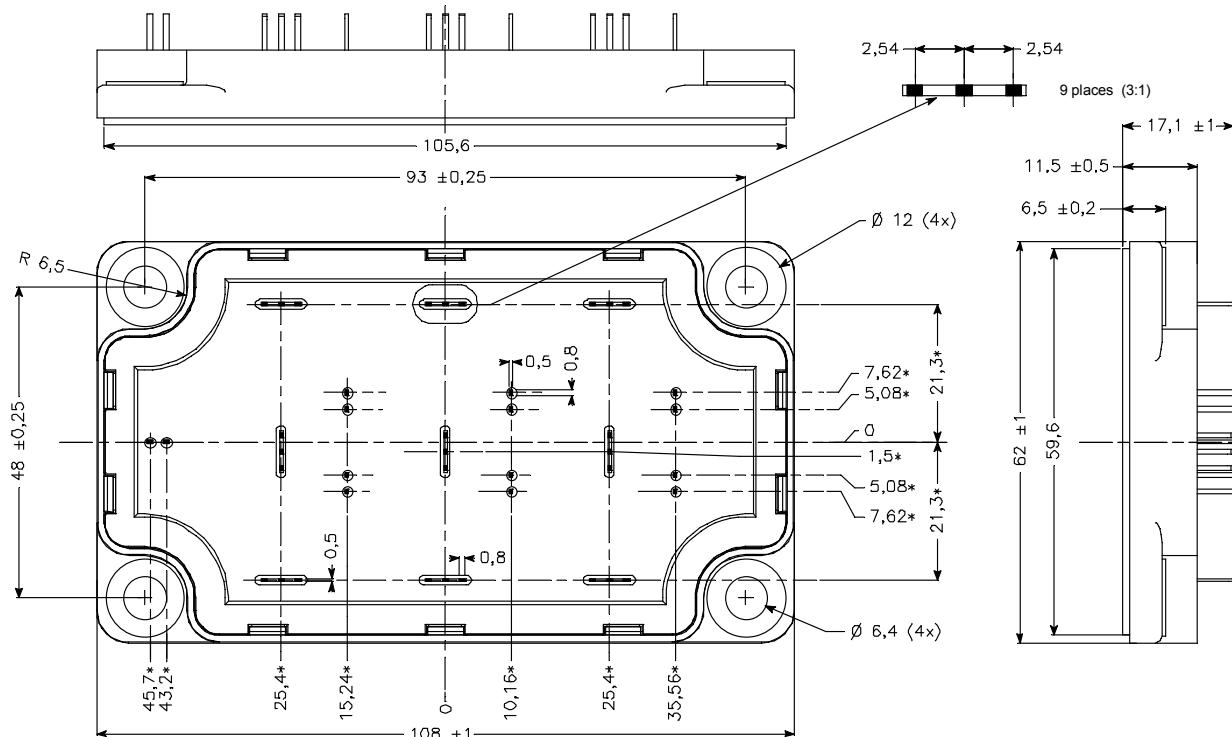
Symbol	Characteristic		Min	Typ	Max	Unit
R _{thJC}	Junction to Case Thermal Resistance				0.27	°C/W
V _{ISOL}	RMS Isolation Voltage, any terminal to case t = 1 min, I _{isol} <1mA, 50/60Hz	4000				V
T _J	Operating junction temperature range	-40		150		°C
T _{STG}	Storage Temperature Range	-40		125		
T _C	Operating Case Temperature	-40		100		
Torque	Mounting torque	To heatsink	M6	3	5	N.m
Wt	Package Weight				250	g

Temperature sensor NTC (see application note APT0406 on www.microsemi.com for more information).

Symbol	Characteristic		Min	Typ	Max	Unit
R ₂₅	Resistance @ 25°C			50		kΩ
ΔR _{25/R25}				5		%
B _{25/85}	T ₂₅ = 298.15 K			3952		K
ΔB/B		T _C =100°C		4		%

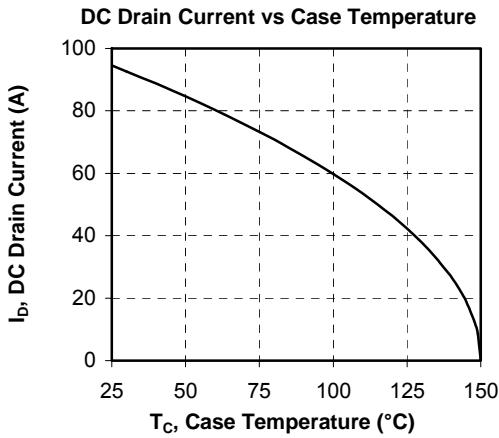
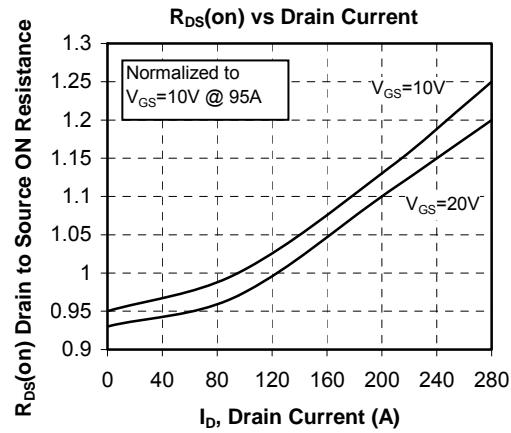
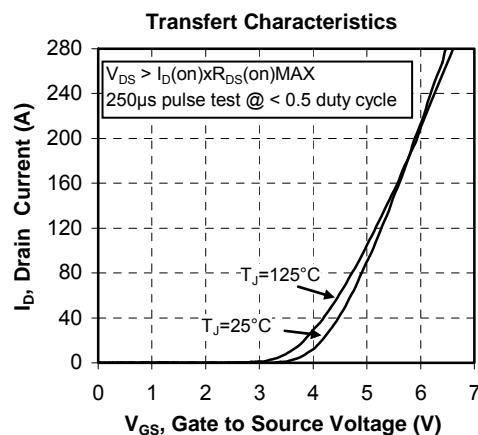
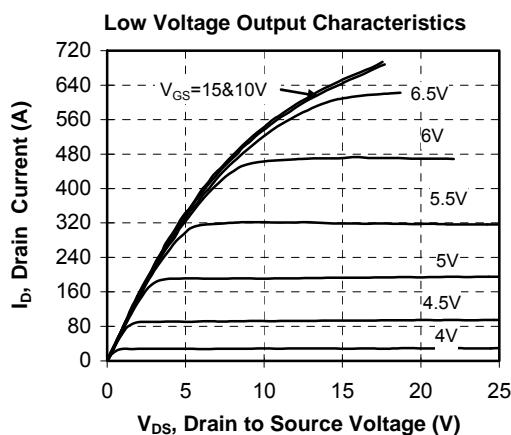
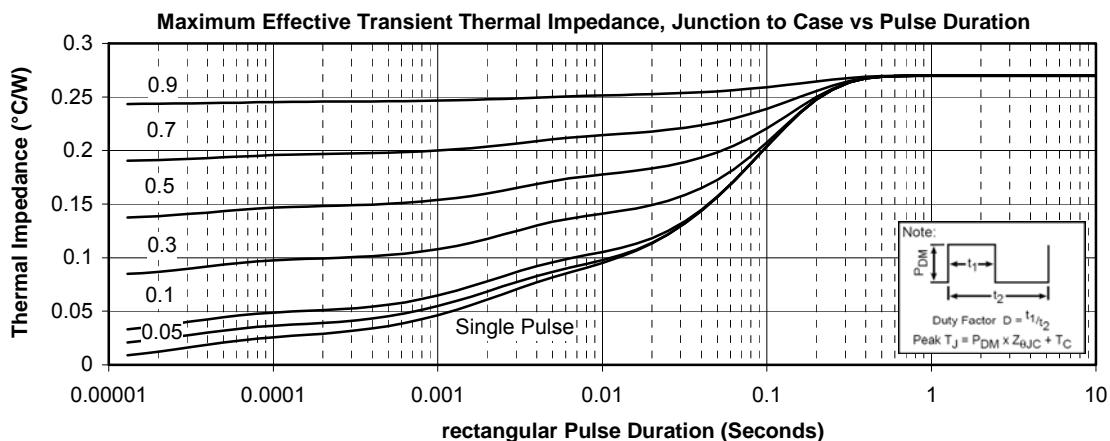
$$R_T = \frac{R_{25}}{\exp\left[B_{25/85}\left(\frac{1}{T_{25}} - \frac{1}{T}\right)\right]} \quad T: \text{ Thermistor temperature}$$

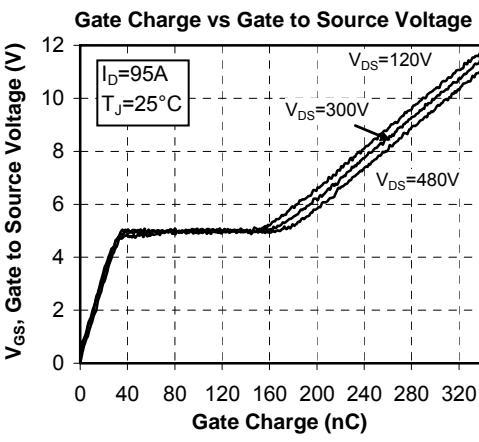
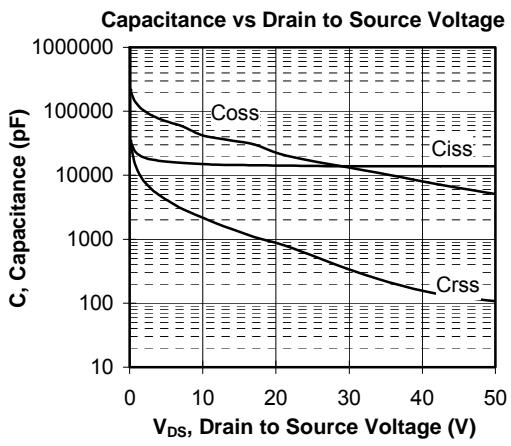
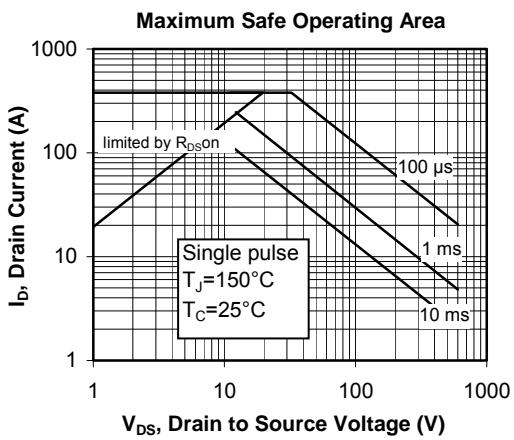
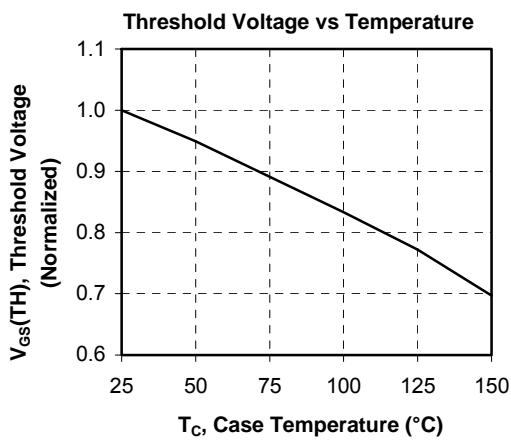
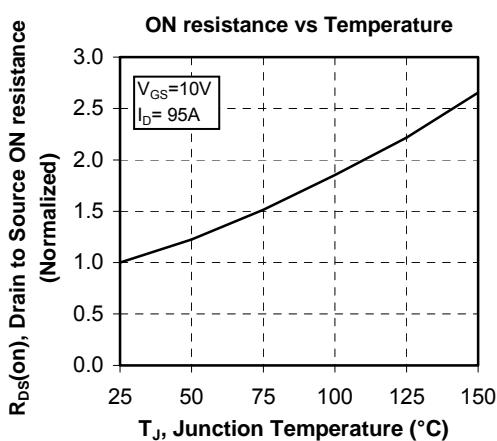
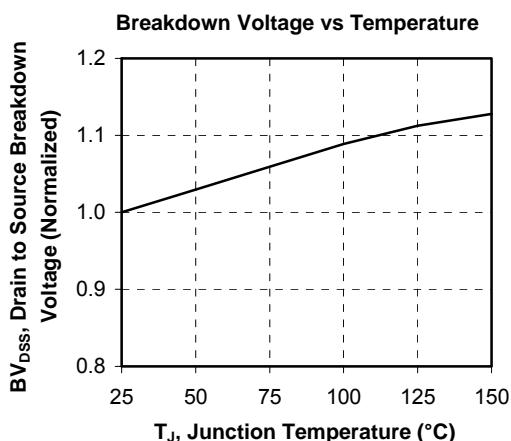
R_T: Thermistor value at T

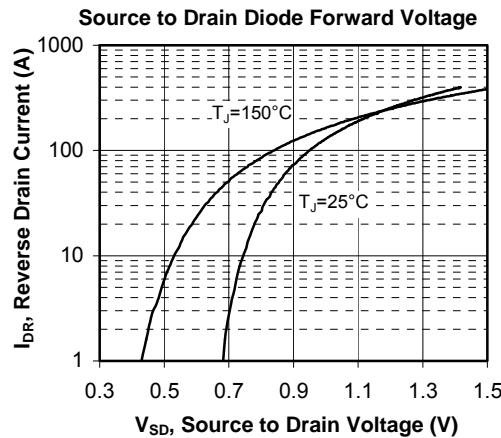
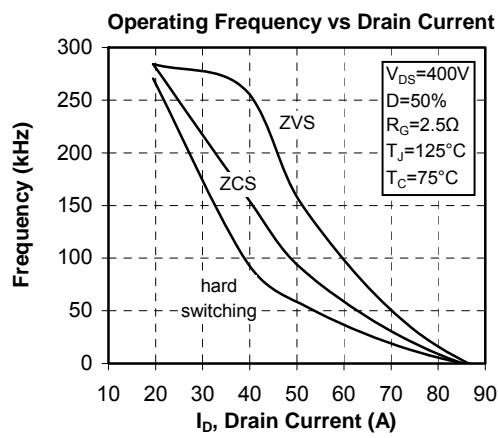
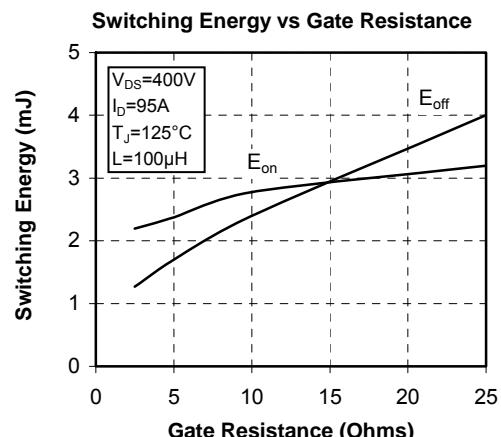
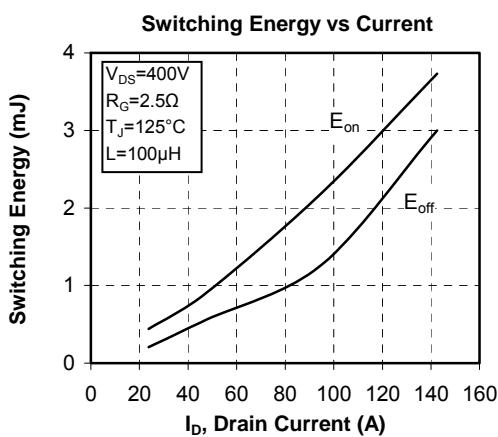
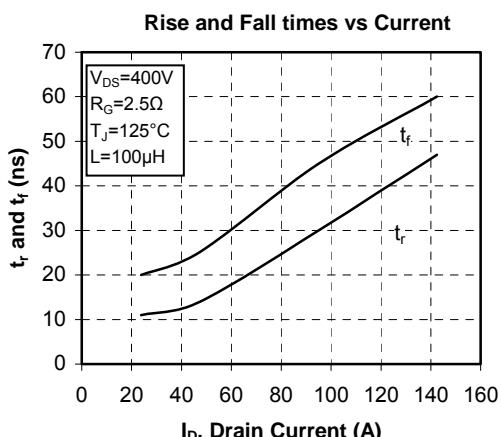
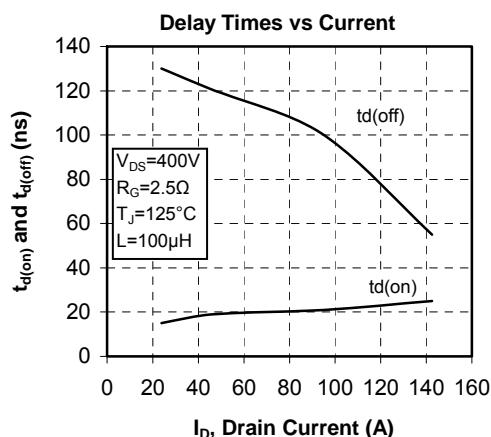
SP6-P Package outline (dimensions in mm)

 ALL DIMENSIONS MARKED *** ARE TOLERENCED AS : 

 See application note 1902 - Mounting Instructions for SP6-P (12mm) Power Modules on www.microsemi.com

Typical Performance Curve







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